## AD5532*

## FEATURES

High Integration: 32-Channel DAC in $12 \mathrm{~mm} \times 12 \mathrm{~mm}$ LFBGA
Adjustable Voltage Output Range
Guaranteed Monotonic
Read-Back Capability
DSP/Microcontroller Compatible Serial Interface
Output Impedance
$0.5 \Omega$ (AD5532-1, AD5532-2)
$500 \Omega$ (AD5532-3)
$1 \mathrm{k} \Omega$ (AD5532-5)
Output Voltage Span
10 V (AD5532-1, AD5532-3, AD5532-5)
20 V (AD5532-2)
Infinite Sample-and-Hold Capability to $\pm 0.018 \%$ Accuracy
Temperature Range $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
APPLICATIONS
Automatic Test Equipment
Optical Networks
Level Setting
Instrumentation
Industrial Control Systems
Data Acquisition
Low Cost I/O

## GENERAL DESCRIPTION

The AD5532 is a 32-channel voltage-output 14-bit DAC with an additional infinite sample-and-hold mode. The selected DAC register is written to via the 3-wire serial interface and $V_{\text {OUT }}$ for this DAC is then updated to reflect the new contents of the DAC register. DAC selection is accomplished via Address Bits A0-A4. The output voltage range is determined by the offset voltage at the OFFS_IN pin and the gain of the output amplifier. It is restricted to a range from $\mathrm{V}_{\mathrm{SS}}+2 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{DD}}-2 \mathrm{~V}$ because of the headroom of the output amplifier.
The device is operated with $\mathrm{AV}_{\mathrm{CC}}=5 \mathrm{~V} \pm 5 \%, \mathrm{DV}_{\mathrm{CC}}=2.7 \mathrm{~V}$ to $5.25 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=-4.75 \mathrm{~V}$ to -16.5 V and $\mathrm{V}_{\mathrm{DD}}=8 \mathrm{~V}$ to 16.5 V and requires a stable 3 V reference on REF_IN as well as an offset voltage on OFFS_IN.

## PRODUCT HIGHLIGHTS

1. 32-channel, 14-bit DAC in one package, guaranteed monotonic.
2. The AD5532 is available in a 74 -lead LFBGA package with a body size of $12 \mathrm{~mm} \times 12 \mathrm{~mm}$.
3. Droopless/Infinite Sample-and-Hold Mode.

*Protected by U.S. Patent No. 5,969,657; other patents pending.
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AD5532-SPEGFFGATIONS $\left(V_{D D}=8 \mathrm{~V}\right.$ to $16.5 \mathrm{~V}, \mathrm{~V}_{S S}=-4.75 \mathrm{~V}$ to -16.5 V ; $\mathrm{AV}_{C C}=4.75 \mathrm{~V}$ to 5.25 V ; $\mathrm{DV} \mathrm{V}_{C C}=2.7 \mathrm{~V}$ to 5.25 V ; AGND = DGND = DAC_GND = $0 \mathrm{~V} ; \mathrm{REF}_{-} \mathrm{IN}=3 \mathrm{~V}$; Output Range from $\mathrm{V}_{S S}+2 \mathrm{~V}$ to $\mathrm{V}_{D D}-2 \mathrm{~V}$. All outputs unloaded. All specifications $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$, unless otherwise noted.)

| Parameter ${ }^{1}$ | A Version ${ }^{2}$ |  | Unit | Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: |
|  | AD5532-1/-3/-5 | AD5532-2 Only |  |  |
| DAC DC PERFORMANCE <br> Resolution <br> Integral Nonlinearity (INL) <br> Differential Nonlinearity (DNL) <br> Offset <br> Gain <br> Full-Scale Error | $\begin{aligned} & 14 \\ & \pm 0.39 \\ & \pm 1 \\ & 90 / 170 / 250 \\ & 3.52 \\ & \pm 2 \end{aligned}$ | $\begin{aligned} & 14 \\ & \pm 0.39 \\ & \pm 1 \\ & 180 / 350 / 500 \\ & 7 \\ & \pm 2 \end{aligned}$ | Bits <br> \% of FSR max <br> LSB max <br> mV min/typ/max <br> typ <br> \% of FSR max | $\pm 0.15 \% \text { typ }$ <br> $\pm 0.5$ LSB typ, Monotonic <br> See Figure 6 |
| VOLTAGE REFERENCE <br> REF_IN <br> Nominal Input Voltage <br> Input Voltage Range ${ }^{3}$ <br> Input Current <br> REF_OUT <br> Output Voltage <br> Output Impedance ${ }^{3}$ <br> Reference Temperature Coefficient ${ }^{3}$ | $\begin{aligned} & 3.0 \\ & 2.85 / 3.15 \\ & 1 \\ & 3 \\ & 280 \\ & 60 \end{aligned}$ | $\begin{aligned} & 3.0 \\ & 2.85 / 3.15 \\ & 1 \\ & \\ & 3 \\ & 280 \\ & 60 \end{aligned}$ | V typ <br> V min/max $\mu \mathrm{A}$ max <br> V typ <br> $\mathrm{k} \Omega$ typ <br> ppm $/{ }^{\circ} \mathrm{C}$ typ | $<1 \mathrm{nA}$ typ |
| ANALOG OUTPUTS (V ${ }_{\text {OUT }} 0-31$ ) Output Temperature Coefficient ${ }^{3,4}$ DC Output Impedance ${ }^{3}$ <br> AD5532-1 <br> AD5532-3 <br> AD5532-5 <br> Output Range <br> Resistive Load ${ }^{3,5}$ <br> Capacitive Load ${ }^{3,5}$ <br> AD5532-1 <br> AD5532-3 <br> AD5532-5 <br> Short-Circuit Current ${ }^{3}$ <br> DC Power-Supply Rejection Ratio ${ }^{3}$ <br> DC Crosstalk ${ }^{3}$ | $\begin{aligned} & 10 \\ & 0.5 \\ & 500 \\ & 1 \\ & \mathrm{~V}_{\mathrm{SS}}+2 / \mathrm{V}_{\mathrm{DD}}-2 \\ & 5 \\ & 500 \\ & 15 \\ & 40 \\ & 7 \\ & -70 \\ & -70 \\ & 250 \end{aligned}$ | $\begin{aligned} & 10 \\ & 0.5 \\ & \mathrm{~V}_{\mathrm{SS}}+2 / \mathrm{V}_{\mathrm{DD}}-2 \\ & 5 \\ & 500 \\ & \\ & 7 \\ & -70 \\ & -70 \\ & 1800 \end{aligned}$ | ppm $/{ }^{\circ} \mathrm{C}$ typ <br> $\Omega$ typ <br> $\Omega$ typ <br> $k \Omega$ typ <br> V min/max <br> $k \Omega$ min <br> pF max <br> nF max <br> nF max <br> mA typ <br> dB typ <br> dB typ <br> $\mu \mathrm{V}$ max | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=+15 \mathrm{~V} \pm 5 \% \\ & \mathrm{~V}_{\mathrm{SS}}=-15 \mathrm{~V} \pm 5 \% \end{aligned}$ |
| ANALOG OUTPUT (OFFS_OUT) Output Temperature Coefficient ${ }^{3,4}$ DC Output Impedance ${ }^{3}$ Output Range Output Current Capacitive Load | $\begin{aligned} & 10 \\ & 1.3 \\ & 50 \text { to REF_IN-12 } \\ & 10 \\ & 100 \end{aligned}$ | $\begin{aligned} & 10 \\ & 1.3 \\ & 50 \text { to REF_IN-12 } \\ & 10 \\ & 100 \end{aligned}$ | ppm $/{ }^{\circ} \mathrm{C}$ typ <br> $k \Omega$ typ <br> mV typ <br> $\mu \mathrm{A}$ max <br> pF max | Source Current |
| DIGITAL INPUTS ${ }^{3}$ <br> Input Current Input Low Voltage <br> Input High Voltage <br> Input Hysteresis (SCLK and $\overline{\mathrm{CS}}$ Only) Input Capacitance | $\begin{aligned} & \pm 10 \\ & 0.8 \\ & 0.4 \\ & 2.4 \\ & 2.0 \\ & 200 \\ & 10 \end{aligned}$ | $\begin{aligned} & \pm 10 \\ & 0.8 \\ & 0.4 \\ & 2.4 \\ & 2.0 \\ & 200 \\ & 10 \end{aligned}$ | $\mu \mathrm{A} \max$ <br> V max <br> V max <br> V min <br> V min <br> mV typ <br> pF max |  |
| DIGITAL OUTPUTS ( $\left.\overline{\text { BUSY }}, \mathrm{D}_{\text {OUT }}\right)^{3}$ Output Low Voltage, $\mathrm{DV}_{\mathrm{CC}}=5 \mathrm{~V}$ Output High Voltage, $\mathrm{DV}_{\mathrm{CC}}=5 \mathrm{~V}$ Output Low Voltage, $\mathrm{DV}_{\mathrm{CC}}=3 \mathrm{~V}$ Output High Voltage, $\mathrm{DV}_{\mathrm{CC}}=3 \mathrm{~V}$ High Impedance Leakage Current High Impedance Output Capacitance | $\begin{aligned} & 0.4 \\ & 4.0 \\ & 0.4 \\ & 2.4 \\ & \pm 1 \\ & 15 \end{aligned}$ | $\begin{aligned} & 0.4 \\ & 4.0 \\ & 0.4 \\ & 2.4 \\ & \pm 1 \\ & 15 \end{aligned}$ | V max <br> V min <br> V max <br> V min <br> $\mu \mathrm{A}$ max <br> pF typ | Sinking $200 \mu \mathrm{~A}$ <br> Sourcing $200 \mu \mathrm{~A}$ <br> Sinking $200 \mu \mathrm{~A}$ <br> Sourcing $200 \mu \mathrm{~A}$ <br> $\mathrm{D}_{\text {Out }}$ Only <br> $\mathrm{D}_{\text {Out }}$ Only |


| Parameter ${ }^{1}$ | A Version ${ }^{2}$ |  | Unit | Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: |
|  | AD5532-1/-3/-5 | AD5532-2 Only |  |  |
| POWER REQUIREMENTS |  |  |  |  |
| Power-Supply Voltages |  |  |  |  |
| $\mathrm{V}_{\mathrm{DD}}$ | 8/16.5 | 8/16.5 | V min/max |  |
| $\mathrm{V}_{\text {SS }}$ | -4.75/-16.5 | -4.75/-16.5 | V min/max |  |
| $\mathrm{AV}_{\mathrm{CC}}$ | 4.75/5.25 | 4.75/5.25 | V min/max |  |
| DV ${ }_{\text {Cc }}$ | 2.7/5.25 | 2.7/5.25 | V min/max |  |
| Power-Supply Currents ${ }^{6}$ |  |  |  |  |
| $\mathrm{I}_{\mathrm{DD}}$ | 15 | 15 | $m A \max$ | 10 mA typ. <br> All Channels Full-Scale |
| $\mathrm{I}_{\text {SS }}$ | 15 | 15 | mA max | 10 mA typ. <br> All Channels Full-Scale |
| AICC | 33 | 33 | mA max | 26 mA typ |
| DICC | 1.5 | 1.5 | mA max | 1 mA typ |
| Power Dissipation ${ }^{6}$ | 280 | 280 | mW typ | $\mathrm{V}_{\mathrm{DD}}=10 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=-5 \mathrm{~V}$ |
| AC CHARACTERISTICS ${ }^{3}$ |  |  |  |  |
| Output Voltage Settling Time | 22 | 30 | $\mu \mathrm{s}$ max | $500 \mathrm{pF}, 5 \mathrm{k} \Omega$ Load Full-Scale Change |
| OFFS_IN Settling Time | 10 | 25 | $\mu \mathrm{s}$ max | $500 \mathrm{pF}, 5 \mathrm{k} \Omega \mathrm{Load}$; 0 V-3 V Step |
| Digital-to-Analog Glitch Impulse | 1 | 1 | nV-s typ | 1 LSB Change Around Major Carry |
| Digital Crosstalk | 5 | 5 | nV-s typ |  |
| Analog Crosstalk | 1 | 1 | nV-s typ |  |
| Digital Feedthrough | 0.2 | 0.2 | nV-s typ |  |
| Output Noise Spectral Density @ 1 kHz | 400 | 400 | $\mathrm{nV} /(\sqrt{\mathrm{Hz}})$ typ |  |

## NOTES

${ }^{1}$ See Terminology.
${ }^{2} \mathrm{~A}$ Version: Industrial temperature range $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; typical at $+25^{\circ} \mathrm{C}$.
${ }^{3}$ Guaranteed by design and characterization, not production tested.
${ }^{4} \mathrm{AD} 780$ as reference for the AD 5532 .
${ }^{5}$ Ensure that you do not exceed $\mathrm{T}_{\mathrm{J}}$ (max). See Maximum Ratings.
${ }^{6}$ Output unloaded.
Specifications subject to change without notice.

| Parameter ${ }^{1}$ | A Version ${ }^{2}$ |  | Unit | Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: |
|  | AD5532-1/-3/-5 | AD5532-2 Only |  |  |
| ANALOG CHANNEL <br> $\mathrm{V}_{\text {IN }}$ to $\mathrm{V}_{\text {OUt }}$ Nonlinearity ${ }^{3}$ <br> Offset Error <br> Gain | $\begin{aligned} & \pm 0.018 \\ & \pm 50 \\ & 3.46 / 3.52 / 3.6 \\ & \hline \end{aligned}$ | $\begin{aligned} & \pm 0.018 \\ & \pm 75 \\ & 6.96 / 7 / 7.02 \end{aligned}$ | ```% max mV max min/typ/max``` | $\pm 0.006 \%$ typ after Offset and Gain Adjustment $\pm 10 \mathrm{mV}$ typ. See Figure 7 . See Figure 7 |
| ANALOG INPUT ( $\mathrm{V}_{\mathrm{IN}}$ ) Input Voltage Range Input Lower Dead Band Input Upper Dead Band Input Current Input Capacitance ${ }^{4}$ | 0 to 3 <br> 70 <br> 40 <br> 1 <br> 20 | 0 to 3 <br> 70 <br> 40 <br> 1 <br> 20 | V mV max mV max $\mu \mathrm{A}$ max pF typ | Nominal Input Range <br> 50 mV typ. Referred to $\mathrm{V}_{\mathrm{IN}}$. <br> See Figure 7 <br> 12 mV typ. Referred to $\mathrm{V}_{\mathrm{IN}}$. <br> See Figure 7 <br> 100 nA typ. <br> $\mathrm{V}_{\text {IN }}$ Acquired on 1 Channel |
| ANALOG INPUT (OFFS_IN) Input Current Input Voltage Range | $\begin{aligned} & 1 \\ & 0 / 4 \end{aligned}$ | $\begin{aligned} & 1 \\ & 0 / 4 \end{aligned}$ | $\mu \mathrm{A}$ max Vmin/max | 100 nA typ <br> Output Range Restricted from $V_{S S}+2 V$ to $V_{D D}-2 V$ |
| AC CHARACTERISTICS <br> Output Settling Time ${ }^{4}$ Acquisition Time AC Crosstalk ${ }^{4}$ | $\begin{aligned} & 3 \\ & 16 \\ & 5 \\ & \hline \end{aligned}$ | $\begin{aligned} & 3 \\ & 16 \\ & 5 \\ & \hline \end{aligned}$ | $\mu_{\mathrm{s}} \max$ $\mu_{\mathrm{s}} \max$ nV-s typ | Output Unloaded |

## NOTES

${ }^{1}$ See Terminology.
${ }^{2} \mathrm{~A}$ version: Industrial temperature range $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; typical at $+25^{\circ} \mathrm{C}$.
${ }^{3}$ Input range 100 mV to 2.96 V .
${ }^{4}$ Guaranteed by design and characterization, not production tested.
Specifications subject to change without notice.

## TIMING CHARACTERISTICS

PARALLEL INTERFACE

| Parameter $^{1,2}$ | Limit at $\mathbf{T}_{\text {MIN }}, \mathbf{T}_{\text {MAX }}$ <br> (A Version) | Unit | Conditions/Comments |
| :--- | :--- | :--- | :--- |
| $\mathrm{t}_{1}$ | 0 | ns min | $\overline{\mathrm{CS}}$ to $\overline{\mathrm{WR}}$ Setup Time |
| $\mathrm{t}_{2}$ | 0 | ns min | $\overline{\mathrm{CS}}$ to $\overline{\mathrm{WR}}$ Hold Time |
| $\mathrm{t}_{3}$ | 50 | ns min | $\overline{\mathrm{CS}}$ Pulsewidth Low |
| $\mathrm{t}_{4}$ | 50 | ns min | $\overline{\mathrm{WR}}$ Pulsewidth Low |
| $\mathrm{t}_{5}$ | 20 | ns min | A4-A0, CAL, OFFS_SEL to $\overline{\mathrm{WR}}$ Setup Time |
| $\mathrm{t}_{6}$ | 7 | ns min | A4-A0, CAL, OFFS_SEL to $\overline{\mathrm{WR}}$ Hold Time |

NOTES
${ }^{1}$ See Interface Timing Diagram.
${ }^{2}$ Guaranteed by design and characterization, not production tested.
Specifications subject to change without notice.

## SERIAL INTERFACE

| Parameter $^{1,2}$ | Limit at T <br> (A Version) | $\mathbf{T}_{\text {MAX }}$ | Unit |
| :--- | :--- | :--- | :--- |$\quad$ Conditions/Comments $\quad$.

## NOTES

${ }^{1}$ See Serial Interface Timing Diagrams.
${ }^{2}$ Guaranteed by design and characterization, not production tested.
${ }^{3}$ In ISHA mode the maximum SCLK frequency is 20 MHz and the minimum pulsewidth is 20 ns .
${ }^{4}$ These numbers are measured with the load circuit of Figure 2.
${ }^{5}$ SYNC should be taken low while SCLK is low for read back.
Specifications subject to change without notice.

## PARALLEL INTERFACE TIMING DIAGRAMS



Figure 1. Parallel Write (ISHA Mode Only)


Figure 2. Load Circuit for Dout Timing Specifications

## SERIAL INTERFACE TIMING DIAGRAMS



Figure 3. 10-Bit Write (ISHA Mode and Both Read-Back Modes)


Figure 4. 24-Bit Write (DAC Mode)


Figure 5. 14-Bit Read (Both Read-Back Modes)

## ABSOLUTE MAXIMUM RATINGS ${ }^{1,2}$

( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ unless otherwise noted.)
$\mathrm{V}_{\mathrm{DD}}$ to AGND . . . . . . . . . . . . . . . . . . . . . . . . -0.3 V to +17 V
V ${ }_{\text {SS }}$ to AGND . . . . . . . . . . . . . . . . . . . . . . . . +0.3 V to -17 V
AV ${ }_{\text {CC }}$ to AGND, DAC_GND . . . . . . . . . . . . . -0.3 V to +7 V
$\mathrm{DV}_{\mathrm{CC}}$ to DGND . . . . . . . . . . . . . . . . . . . . . . . -0.3 V to +7 V
Digital Inputs to DGND . . . . . . . . . -0.3 V to $\mathrm{DV}_{\mathrm{CC}}+0.3 \mathrm{~V}$
Digital Outputs to DGND . . . . . . . . -0.3 V to $\mathrm{DV}_{\mathrm{CC}}+0.3 \mathrm{~V}$
REF_IN to AGND, DAC_ GND ... -0.3 V to $\mathrm{AV}_{\mathrm{CC}}+0.3 \mathrm{~V}$
$\mathrm{V}_{\text {IN }}$ to AGND, DAC_GND . . . . . . . . -0.3 V to $\mathrm{AV}_{\mathrm{CC}}+0.3 \mathrm{~V}$
$\mathrm{V}_{\text {OUT }} 0-31$ to AGND . . . . . . . . . . $\mathrm{V}_{\text {SS }}-0.3 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
OFFS_IN to AGND . . . . . . . . . V VSS -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
OFFS_OUT to AGND .... AGND - 0.3 V to $\mathrm{AV}_{\mathrm{CC}}+0.3 \mathrm{~V}$
AGND to DGND . . . . . . . . . . . . . . . . . . . . -0.3 V to +0.3 V
Operating Temperature Range
Industrial . . . . . . . . . . . . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Junction Temperature ( $\mathrm{T}_{\mathrm{J}}$ max) . . . . . . . . . . . . . . . . . . $150^{\circ} \mathrm{C}$
74-Lead LFBGA Package, $\theta_{J A}$ Thermal Impedance . . . $41^{\circ} \mathrm{C} / \mathrm{W}$

## Reflow Soldering

Peak Temperature . . . . . . . . . . . . . . . . . . . . . . . . . . $220^{\circ} \mathrm{C}$
Time at Peak Temperature . . . . . . . . . . . . 10 sec to 40 sec
Max Power Dissipation . . . . . . . . . . $\left(150^{\circ} \mathrm{C}-\mathrm{T}_{\mathrm{A}}\right) / \theta_{\mathrm{JA}} \mathrm{mW}^{3}$
Max Continuous Load Current at $\mathrm{T}_{\mathrm{J}}=70^{\circ} \mathrm{C}$, per Channel Group . . . . . . . . . . . . . . . . . . . . . . . . . 15 mA $^{4}$
NOTES
${ }^{1}$ Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2}$ Transient currents of up to 100 mA will not cause SCR latch-up.
${ }^{3}$ This limit includes load power.
${ }^{4}$ This maximum allowed continuous load current is spread over 8 channels and channels are grouped as follows:
Group 1: Channels 3, 4, 5, 6, 7, 8, 9, 10
Group 2: Channels 14, 16, 18, 20. 21, 24, 25, 26
Group 3: Channels 15, 17, 19, 22, 23, 27, 28, 29
Group 4: Channels $0,1,2,11,12,13,30,31$
For higher junction temperatures derate as follows:

| $\mathbf{T}_{\mathbf{J}}\left({ }^{\circ} \mathbf{C}\right)$ | Max Continuous Load Current <br> per Group $(\mathbf{m A})$ |
| :--- | :--- |
| 70 | 15.5 |
| 90 | 9.025 |
| 100 | 6.925 |
| 110 | 5.175 |
| 125 | 3.425 |
| 135 | 2.55 |
| 150 | 1.5 |

## ORDERING GUIDE

| Model | Function | Output Impedance | Output <br> Voltage Span | Package Description | Package Option |
| :---: | :---: | :---: | :---: | :---: | :---: |
| AD5532ABC-1 | 32 DACs, 32-Channel ISHA | $0.5 \mathrm{k} \Omega$ typ | 10 V | 74-Lead LFBGA | BC-74 |
| AD5532ABC-2 | 32 DACs, 32-Channel ISHA | $0.5 \mathrm{k} \Omega$ typ | 20 V | 74-Lead LFBGA | BC-74 |
| AD5532ABC-3 | 32 DACs, 32-Channel ISHA | $500 \mathrm{k} \Omega$ typ | 10 V | 74-Lead LFBGA | BC-74 |
| AD5532ABC-5 | 32 DACs, 32-Channel ISHA | $1 \mathrm{k} \Omega$ typ | 10 V | 74-Lead LFBGA | BC-74 |
| AD5532BBC-1* | 32 DACs, 32-Channel Precision ISHA | $0.5 \mathrm{k} \Omega$ typ | 10 V | 74-Lead LFBGA | BC-74 |
| AD5533ABC-1* | 32-Channel ISHA Only | $0.5 \mathrm{k} \Omega$ typ | 10 V | 74-Lead LFBGA | BC-74 |
| AD5533BBC-1* | 32-Channel Precision ISHA Only | $0.5 \mathrm{k} \Omega$ typ | 10 V | 74-Lead LFBGA | BC-74 |
| AD5532HS* | 32-Channel High Speed DAC | $0.5 \mathrm{k} \Omega$ typ | 5 V | 74-Lead LFBGA | BC-74 |
| EVAL-AD5532EB | Evaluation Board |  |  |  |  |

*Separate Data Sheet

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD5532 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


## PIN CONFIGURATION



74-Lead LFBGA Ball Configuration

| LFBGA <br> Number | Ball <br> Name | LFBGA <br> Number | Ball <br> Name | LFBGA <br> Number | Ball <br> Name |
| :---: | :---: | :---: | :---: | :---: | :---: |
| A1 | N/C* | C10 | $\mathrm{AV}_{\mathrm{CC}} 1$ | J10 | VO9 |
| A2 | A4 | C11 | REF_OUT | J11 | VO11 |
| A3 | A2 | D1 | VO20 | K1 | VO17 |
| A4 | A0 | D2 | DAC_GND2 | K2 | VO15 |
| A5 | $\overline{\text { CS }} / \overline{\text { SYNC }}$ | D10 | $\mathrm{AV}_{\mathrm{CC}} 2$ | K3 | VO27 |
| A6 | $\mathrm{DV}_{\mathrm{Cc}}$ | D11 | OFFS_OUT | K4 | Vss 3 |
| A7 | SCLK | E1 | VO26 | K5 | $\mathrm{V}_{\text {SS }} 1$ |
| A8 | OFFSET_SEL | E2 | VO14 | K6 | $\mathrm{V}_{\text {SS }} 4$ |
| A9 | BUSY | E10 | AGND1 | K7 | $\mathrm{V}_{\mathrm{DD}} 2$ |
| A10 | $\overline{\text { TRACK }} / \overline{\text { RESET }}$ | E11 | OFFS_IN | K8 | VO2 |
| A11 | N/C* | F1 | VO25 | K9 | VO10 |
| B1 | VO16 | F2 | VO21 | K10 | VO13 |
| B2 | N/C* | F10 | AGND2 | K11 | VO12 |
| B3 | A3 | F11 | VO6 | L1 | N/C* |
| B4 | A1 | G1 | VO24 | L2 | VO28 |
| B5 | WR | G2 | VO8 | L3 | VO29 |
| B6 | DGND | G10 | VO5 | L4 | VO30 |
| B7 | $\mathrm{D}_{\text {IN }}$ | G11 | VO3 | L5 | $\mathrm{V}_{\mathrm{DD}} 3$ |
| B8 | CAL | H1 | VO23 | L6 | $\mathrm{V}_{\mathrm{DD}} 1$ |
| B9 | SER/PAR | H2 | VIN | L7 | $\mathrm{V}_{\mathrm{DD}} 4$ |
| B10 | DOUT | H10 | VO4 | L8 | VO31 |
| B11 | REF_IN | H11 | VO7 | L9 | VO0 |
| C1 | VO18 | J1 | VO22 | L10 | VO1 |
| C2 | DAC_GND1 | J2 | VO19 | L11 | N/C* |
| C6 | N/C* | J6 | $\mathrm{V}_{\text {SS }} 2$ |  |  |

[^1]
## PIN FUNCTION DESCRIPTION

| Pin | Function |
| :---: | :---: |
| AGND (1-2) | Analog GND Pins |
| $\mathrm{AV}_{\mathrm{CC}}(1-2)$ | Analog Supply Pins. Voltage range from 4.75 V to 5.25 V . |
| $\mathrm{V}_{\mathrm{DD}}(1-4)$ | $\mathrm{V}_{\mathrm{DD}}$ Supply Pins. Voltage range from 8 V to 16.5 V . |
| $\mathrm{V}_{\text {SS }}(1-4)$ | $\mathrm{V}_{\text {SS }}$ Supply Pins. Voltage range from -4.75 V to -16.5 V . |
| DGND | Digital GND Pins |
| DV ${ }_{\text {CC }}$ | Digital Supply Pins. Voltage range from 2.7 V to 5.25 V. |
| DAC_GND (1-2) | Reference GND Supply for All the DACs |
| REF_IN | Reference Voltage for Channels 0-31 |
| REF_OUT | Reference Output Voltage |
| $\mathrm{V}_{\text {Out }}(0-31)$ | Analog Output Voltages from the 32 Channels |
| $\mathrm{V}_{\text {IN }}$ | Analog Input Voltage. Connect this to AGND if operating in DAC mode only. |
| A4-A $1^{1}, \mathrm{~A} 0^{2}$ | Parallel Interface: 5-Address Pins for 32 Channels. A $4=$ MSB of Channel Address. A0 $=$ LSB. |
| CAL ${ }^{1}$ | Parallel Interface: Control input that allows all 32 channels to acquire $\mathrm{V}_{\text {IN }}$ simultaneously. |
| $\overline{\text { CS/SYNC }}$ | This pin is both the active low Chip Select pin for the parallel interface and the Frame Synchronization pin for the serial interface. |
| $\overline{\mathrm{WR}}^{1}$ | Parallel Interface: Write pin. Active low. This is used in conjunction with the $\overline{\mathrm{CS}}$ pin to address the device using the parallel interface. |
| OFFSET_SEL ${ }^{1}$ | Parallel Interface: Offset Select pin. Active high. This is used to select the offset channel. |
| SCLK ${ }^{2}$ | Serial Clock Input for Serial Interface. This operates at clock speeds up to 14 MHz ( 20 MHz in ISHA mode). |
| $\mathrm{D}_{\mathrm{IN}}{ }^{2}$ | Data Input for Serial Interface. Data must be valid on the falling edge of SCLK. |
| $\mathrm{D}_{\text {OUT }}$ | Output from the DAC Registers for read back. Data is clocked out on the rising edge of SCLK and is valid on the falling edge of SCLK. |
| $\mathrm{SER} / \overline{\mathrm{PAR}}^{1}$ | This pin allows the user to select whether the serial or parallel interface will be used. If the pin is tied low, the parallel interface will be used. If it is tied high, the serial interface will be used. |
| OFFS_IN | Offset Input. The user can supply a voltage here to offset the output span. OFFS_OUT can also be tied to this pin if the user wants to drive this pin with the Offset Channel. |
| OFFS_OUT | Offset Output. This is the acquired/programmed offset voltage which can be tied to OFFS_IN to offset the span. |
| $\overline{\text { BUSY }}$ | This output tells the user when the input voltage is being acquired. It goes low during acquisition and returns high when the acquisition operation is complete. |
| $\overline{\text { TRACK }} / \overline{\text { RESET }}^{2}$ | If this input is held high, $\mathrm{V}_{\mathrm{IN}}$ is acquired once the channel is addressed. While it is held low, the input to the gain/offset stage is switched directly to $\mathrm{V}_{\mathrm{IN}}$. The addressed channel begins to acquire $\mathrm{V}_{\text {IN }}$ on the rising edge of TRACK. See TRACK Input section for further information. This input can also be used as a means of resetting the complete device to its power-on-reset conditions. This is achieved by applying a low-going pulse of between 90 ns and 200 ns to this pin. See section on $\overline{\text { RESET }}$ Function for further details. |

## NOTES

${ }^{1}$ Internal pull-down devices on these logic inputs. Therefore, they can be left floating and will default to a logic low condition.
${ }^{2}$ Internal pull-up devices on these logic inputs. Therefore, they can be left floating and will default to a logic high condition.


Figure 6. DAC Transfer Function (OFFS_IN =0)


Figure 7. ISHA Transfer Function

## TERMINOLOGY

## DAC MODE

## Integral Nonlinearity (INL)

This is a measure of the maximum deviation from a straight line passing through the endpoints of the DAC transfer function. It is expressed as a percentage of full-scale span.

## Differential Nonlinearity (DNL)

Differential nonlinearity (DNL) is the difference between the measured change and the ideal 1 LSB change between any two adjacent codes. A specified DNL of $\pm 1$ LSB maximum ensures monotonicity.

## Offset

Offset is a measure of the output with all zeros loaded to the DAC and OFFS_IN $=0$. Since the DAC is lifted off the ground by approximately 50 mV , this output will typically be:

$$
V_{\text {OUT }}=\text { Gain } \times 50 \mathrm{mV}
$$

## Full-Scale Error

This is a measure of the output error with all 1 s loaded to the DAC. It is expressed as a percentage of full-scale range. See Figure 6. It is calculated as:

$$
\text { Full-Scale Error }=V_{\text {OUT }(\text { Full-Scale })}-(\text { Ideal Gain } \times \text { REFIN })
$$

where
Ideal Gain $=3.52$ for AD5532-1/-3/-5
Ideal Gain $=7$ for AD5532-2

## Output Settling Time

This is the time taken from when the last data bit is clocked into the DAC until the output has settled to within $\pm 0.39 \%$.

## OFFS_IN Settling Time

This is the time taken from a $0 \mathrm{~V}-3 \mathrm{~V}$ step change in input voltage on OFFS_IN until the output has settled to within $\pm 0.39 \%$.

## Digital-to-Analog Glitch Impulse

This is the area of the glitch injected into the analog output when the code in the DAC register changes state. It is specified as the area of the glitch in nV -secs when the digital code is changed by 1 LSB at the major carry transition ( $011 \ldots 11$ to $100 \ldots 00$ or 100... 00 to $011 \ldots 11$ ).

## Digital Crosstalk

This is the glitch impulse transferred to the output of one DAC at midscale while a full-scale code change (all 1 s to all 0 s and vice versa) is being written to another DAC. It is expressed in nV -secs.

## Analog Crosstalk

This is the area of the glitch transferred to the output ( $\mathrm{V}_{\text {OUT }}$ ) of one DAC due to a full-scale change in the output ( $\mathrm{V}_{\text {OUT }}$ ) of another DAC. The area of the glitch is expressed in nV-secs.

## Digital Feedthrough

This is a measure of the impulse injected into the analog outputs from the digital control inputs when the part is not being written to, i.e., $\overline{\mathrm{CS}} / \overline{\mathrm{SYNC}}$ is high. It is specified in nV-secs and is measured with a worst-case change on the digital input pins, e.g., from all 0 s to all 1 s and vice versa.

## Output Noise Spectral Density

This is a measure of internally generated random noise. Random noise is characterized as a spectral density (voltage per root Hertz). It is measured by loading all DACs to midscale and measuring noise at the output. It is measured in $\mathrm{nV} /(\sqrt{\mathrm{Hz}})$.

## Output Temperature Coefficient

This is a measure of the change in analog output with changes in temperature. It is expressed in $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$.

## DC Power-Supply Rejection Ratio

DC power-supply rejection ratio (PSRR) is a measure of the change in analog output for a change in supply voltage ( $\mathrm{V}_{\mathrm{DD}}$ and $\mathrm{V}_{\text {SS }}$ ). It is expressed in $\mathrm{dBs} . \mathrm{V}_{\mathrm{DD}}$ and $\mathrm{V}_{\text {SS }}$ are varied $\pm 5 \%$.

## DC Crosstalk

This is the DC change in the output level of one DAC at midscale in response to a full-scale code change (all 0 s to all 1 s and vice versa) and output change of all other DACs. It is expressed in $\mu \mathrm{V}$.

## ISHA MODE

## $\mathbf{V}_{\text {IN }}$ to $\mathbf{V}_{\text {out }}$ Nonlinearity

This is a measure of the maximum deviation from a straight line passing through the endpoints of the $\mathrm{V}_{\text {IN }}$ versus $\mathrm{V}_{\text {OUT }}$ transfer function. It is expressed as a percentage of the full-scale span.

## Offset Error

This is a measure of the output error when $\mathrm{V}_{\mathrm{IN}}=70 \mathrm{mV}$. Ideally, with $\mathrm{V}_{\mathrm{IN}}=70 \mathrm{mV}$ :

$$
V_{\text {OUT }}=(\text { Gain } \times 70)-\left((\text { Gain }-1) \times V_{\text {OFFS_IN }}\right) m V
$$

Offset error is a measure of the difference between $V_{\text {OUT }}$ (actual) and $\mathrm{V}_{\text {OUT }}$ (ideal). It is expressed in mV and can be positive or negative. See Figure 7.

## Gain Error

This is a measure of the span error of the analog channel. It is the deviation in slope of the transfer function expressed in mV . See Figure 7. It is calculated as:
Gain Error = Actual Full-Scale Output - Ideal Full-Scale Output Offset Error
where
Ideal Full-Scale Output $=$ Gain $\times 2.96-\left((\right.$ Gain -1$\left.) \times V_{\text {OFFS_IN }}\right)$

## AC Crosstalk

This is the area of the glitch that occurs on the output of one channel while another channel is acquiring. It is expressed in nV-secs.

## Output Settling Time

This is the time taken from when BUSY goes high to when the output has settled to $\pm 0.018 \%$.

## Acquisition Time

This is the time taken for the $\mathrm{V}_{\text {IN }}$ input to be acquired. It is the length of time that $\overline{\mathrm{BUSY}}$ stays low.


TPC 1. Typical DNL Plot


TPC 4. V Capability


TPC 7. $V_{\text {IN }}$ to $V_{\text {OUT }}$ Accuracy
After Offset and Gain Adjustment (ISHA Mode)


TPC 2. INL Error and DNL Error vs. Temperature


TPC 5. Full-Scale Settling Time


TPC 8. Acquisition Time and Output Settling Time (ISHA Mode)


TPC 3. Vout vs. Temperature


TPC 6. Major Code Transition Glitch Impulse


TPC 9. ISHA-Mode Repeatability (64 K Acquisitions)

## FUNCTIONAL DESCRIPTION

The AD5532 can be thought of as consisting of 32 DACs and an ADC (for ISHA Mode) in a single package. In DAC Mode, a 14-bit digital word is loaded into one of the 32 DAC Registers via the serial interface. This is then converted (with gain and offset) into an analog output voltage ( $\mathrm{V}_{\text {OUT }} 0-\mathrm{V}_{\text {OUT }} 31$ ).
To update a DAC's output voltage, the required DAC is addressed via the serial port. When the DAC address and code have been loaded, the selected DAC converts the code.
On power-on, all the DACs, including the offset channel, are loaded with zeros. Each of the 33 DACs is offset internally by 50 mV (typ) from GND, so the outputs $\mathrm{V}_{\text {OUT }} 0$ to $\mathrm{V}_{\text {OUT }} 31$ are 50 mV (typ) on power-on if the OFFS_IN pin is driven directly by the on-board offset channel (OFFS_OUT), i.e. if OFFS_IN is $50 \mathrm{mV}, \mathrm{V}_{\text {OUT }}=\left(\right.$ Gain $\left.\times \mathrm{V}_{\text {DAC }}\right)-($ Gain -1$) \times \mathrm{V}_{\text {OFFS_IN }}=50 \mathrm{mV}$.

Output Buffer Stage-Gain and Offset
The function of the output buffer stage is to translate the $50 \mathrm{mV}-3 \mathrm{~V}$ output of the DAC to a wider range. This is done by gaining up the DAC output by 3.52/7 and offsetting the voltage by the voltage on OFFS_IN pin.

## AD5532-1/AD5532-3/AD5532-5:

$$
V_{\text {OUT }}=3.52 \times V_{D A C}-2.52 \times V_{\text {OFFS_IN }}
$$

AD5532-2:

$$
V_{\text {OUT }}=7 \times V_{D A C}-6 \times V_{\text {OFFS_IN }}
$$

$V_{D A C}$ is the output of the DAC.
$V_{\text {OFFS_IN }}$ is the voltage at the OFFS_IN pin.
The following table shows how the output range on $\mathrm{V}_{\text {OUT }}$ relates to the offset voltage supplied by the user.

Table I. Sample Output Voltage Ranges

| $\mathbf{V}_{\text {OFFS_IN }}$ <br> (V) | $\mathbf{V}_{\text {DAC }}$ <br> (V) | $\mathbf{V}_{\text {OUT }}$ <br> (AD5532-1/-3/-5) | $\mathbf{V}_{\text {OUT }}$ <br> (AD5532-2) |
| :--- | :--- | :--- | :--- |
| 0.5 | 0.05 to 3 | -1.26 to +9.3 | Headroom Limited |
| 1 | 0.05 to 3 | -2.52 to +8.04 | -6 to +15 |

$\mathrm{V}_{\text {Out }}$ is limited only by the headroom of the output amplifiers. $V_{\text {OUT }}$ must be within maximum ratings.

## Offset Voltage Channel

The offset voltage can be externally supplied by the user at OFFS_IN or it can be supplied by an additional offset voltage channel on the device itself. The offset can be set up in two ways. In ISHA Mode, the required offset voltage is set up on $\mathrm{V}_{\text {IN }}$ and acquired by the offset channel. In DAC Mode, the code corresponding to the offset value is loaded directly into the offset DAC. This offset channel's DAC output is directly connected to OFFS_OUT. By connecting OFFS_OUT to OFFS_IN this offset voltage can be used as the offset voltage for the 32 output amplifiers. It is important to choose the offset so that $\mathrm{V}_{\text {OUT }}$ is within maximum ratings.

## Reset Function

The reset function on the AD5532 can be used to reset all nodes on this device to their power-on-reset condition. This is implemented by applying a low-going pulse of between 90 ns and 200 ns to the $\overline{\text { TRACK }} / \overline{\operatorname{RESET}}$ pin on the device. If the applied pulse is less than 90 ns , it is assumed to be a glitch and no operation takes
place. If the applied pulse is wider than 200 ns , this pin adopts its track function on the selected channel, $\mathrm{V}_{\mathrm{IN}}$ is switched to the output buffer, and an acquisition on the channel will not occur until a rising edge of TRACK.

## ISHA Mode

In ISHA Mode, the input voltage $\mathrm{V}_{\text {IN }}$ is sampled and converted into a digital word. The noninverting input to the output buffer (gain and offset stage) is tied to $\mathrm{V}_{\text {IN }}$ during the acquisition period to avoid spurious outputs, while the DAC acquires the correct code. This is completed in $16 \mu \mathrm{~s}$ max. At this time the updated DAC output assumes control of the output voltage. The output voltage of the DAC is connected to the noninverting input of the output buffer. Since the channel output voltage is effectively the output of a DAC, there is no droop associated with it. As long as power is maintained to the device, the output voltage will remain constant until this channel is addressed again. Since the internal DACs are offset by 70 mV (max) from GND, the minimum $\mathrm{V}_{\text {IN }}$ in ISHA Mode is 70 mV . The maximum $\mathrm{V}_{\text {IN }}$ is 2.96 V due to the upper dead band of 40 mV (max).

## Analog Input (ISHA Mode)

The equivalent analog input circuit is shown in Figure 8. The Capacitor C 1 is typically 20 pF and can be attributed to pin capacitance and 32 off-channels. When a channel is selected, an extra 7.5 pF (typ) is switched in. This Capacitor C2 is charged to the previously acquired voltage on that particular channel so it must charge/discharge to the new level. It is essential that the external source can charge/discharge this additional capacitance within $1 \mu \mathrm{~s}-2 \mu \mathrm{~s}$ of channel selection so that $\mathrm{V}_{\text {IN }}$ can be acquired accurately. For this reason, a low impedance source is recommended.


Figure 8. Analog Input Circuit
Large source impedances will significantly affect the performance of the ADC. This may necessitate the use of an input buffer amplifier.

## TRACK Function (ISHA Mode)

Normally in ISHA Mode of operation TRACK is held high and the channel begins to acquire when it is addressed. However, if TRACK is low when the channel is addressed, $\mathrm{V}_{\mathrm{IN}}$ is switched to the output buffer and an acquisition on the channel will not occur until a rising edge of $\overline{\text { TRACK. At this stage, the BUSY }}$ pin will go low until the acquisition is complete, at which point the DAC assumes control of the voltage to the output buffer and $\mathrm{V}_{\text {IN }}$ is free to change again without affecting this output value.

This is useful in an application where the user wants to ramp up $\mathrm{V}_{\text {IN }}$ until $\mathrm{V}_{\text {OUT }}$ reaches a particular level (Figure 9). $\mathrm{V}_{\text {IN }}$ does not need to be acquired continuously while it is ramping up. TRACK


Figure 9. Typical ATE Circuit Using $\overline{\text { TRACK }}$ Input
can be kept low and only when $V_{\text {OUT }}$ has reached its desired voltage is TRACK brought high. At this stage, the acquisition of $\mathrm{V}_{\text {IN }}$ begins.
In the example shown, a desired voltage is required on the output of the pin driver. This voltage is represented by one input to a comparator. The microcontroller/microprocessor ramps up the input voltage on $V_{\text {IN }}$ through a DAC. $\overline{\text { TRACK }}$ is kept low while the voltage on $V_{\text {IN }}$ ramps up so that $V_{\text {IN }}$ is not continually acquired. When the desired voltage is reached on the output of the pin driver, the comparator output switches. The $\mu \mathrm{C} / \mu \mathrm{P}$ then knows what code is required to be input to obtain the desired voltage at the DUT. The TRACK input is now brought high and the part begins to acquire $\mathrm{V}_{\text {IN }}$. At this stage $\overline{\mathrm{BUSY}}$ goes low until $\mathrm{V}_{\text {IN }}$ has been acquired. The output buffer is then switched from $V_{\text {IN }}$ to the output of the DAC.

## MODES OF OPERATION

The AD5532 can be used in four different modes of operation. These modes are set by two mode bits, the first two bits in the serial word.

Table II. Modes of Operation

| Mode Bit 1 | Mode Bit 2 | Operating Mode |
| :--- | :--- | :--- |
| 0 | 0 | ISHA Mode |
| 0 | 1 | DAC Mode |
| 1 | 0 | Acquire and Read Back |
| 1 | 1 | Read Back |

## 1. ISHA Mode

In this mode, a channel is addressed and that channel acquires the voltage on $\mathrm{V}_{\mathrm{IN}}$. This mode requires a 10-bit write (see Figure 10a) to address the relevant channel $\left(\mathrm{V}_{\text {OUT }} 0-\mathrm{V}_{\text {OUT }} 31\right.$, offset channel or all channels) MSB is written first.

## 2. DAC Mode

In this standard mode, a selected DAC register is loaded serially. This requires a 24-bit write ( 10 bits to address the relevant DAC plus an extra 14 bits of DAC data). MSB is written first. The user must allow $400 \mathrm{~ns}(\mathrm{~min})$ between successive writes in DAC Mode.

## 3. Acquire and Read-Back Mode

This mode allows the user to acquire $\mathrm{V}_{\text {IN }}$ and read back the data in a particular DAC register. The relevant channel is addressed (10-bit write, MSB first) and $\mathrm{V}_{\text {IN }}$ is acquired in $16 \mu \mathrm{~s}$ (max). Following the acquisition, after the next falling edge of $\overline{\text { SYNC, }}$ the data in the relevant DAC register is clocked out onto the $\mathrm{D}_{\text {OUT }}$ line in a 14 -bit serial format. The full acquisition time must elapse before the DAC register data can be clocked out.

## 4. Read Back Mode

Again, this is a Read-Back Mode but no acquisition is performed. The relevant channel is addressed (10-bit write, MSB first) and
on the next falling edge of $\overline{\text { SYNC }}$, the data in the relevant DAC register is clocked out onto the $\mathrm{D}_{\text {OUT }}$ line in a 14 -bit serial format. The user must allow $400 \mathrm{~ns}(\mathrm{~min}$ ) between the last SCLK falling edge in the 10 -bit write and the falling edge of $\overline{S Y N C}$ in the 14 -bit read back. The serial write and read words can be seen in Figure 10.
This feature allows the user to read back the DAC register code of any of the channels. In DAC Mode, this is useful in verification of write cycles. In ISHA Mode, read back is useful if the system has been calibrated and the user wants to know what code in the DAC corresponds to a desired voltage on $V_{\text {Out }}$. If the user requires this voltage again, he can input the code directly to the DAC register without going through the acquisition sequence.

## INTERFACES

## Serial Interface

The SER $\overline{\operatorname{PAR}}$ pin is tied high to enable the serial interface and to disable the parallel interface. The serial interface is controlled by the four pins that follow.

## $\overline{S Y N C}, D_{\text {IN }}, S C L K$

Standard 3-wire interface pins. The $\overline{\text { SYNC }}$ pin is shared with the $\overline{\mathrm{CS}}$ function of the parallel interface.

## $D_{\text {out }}$

Data Out pin for reading back the contents of the DAC registers. The data is clocked out on the rising edge of SCLK and is valid on the falling edge of SCLK.

## Mode Bits

There are four different modes of operation as described above.

## Cal Bit

In DAC Mode, this is a test bit. When it is high, it is used to load all zeros or all ones to the 32 DACs simultaneously. In ISHA Mode, all 32 channels acquire $\mathrm{V}_{\text {IN }}$ simultaneously when this bit is high. In ISHA Mode, the acquisition time is then $45 \mu \mathrm{~s}$ (typ) and accuracy may be reduced. This bit is set low for normal operation.

## Offset_Sel Bit

If this is set high, the offset channel is selected and Bits A4A0 are ignored.

## Test Bit

This must be set low for correct operation of the part.

## A4-A0

Used to address any one of the 32 channels (A4 $=$ MSB of address, A0 = LSB).

## DB13-DB0

These are used to write a 14 -bit word into the addressed DAC register. Clearly, this is only valid when in DAC Mode.

a. 10-Bit Input Serial Write Word (ISHA Mode)

b. 24-Bit Input Serial Write Word (DAC Mode)

c. Input Serial Interface (Acquire and Read-Back Mode)

d. Input Serial Interface (Read-Back Mode)

Figure 10. Serial Interface Formats

The serial interface is designed to allow easy interfacing to most microcontrollers and DSPs, e.g., PIC16C, PIC17C, QSPI, SPI, DSP56000, TMS320, and ADSP-21xx, without the need for any glue logic. When interfacing to the 8051, the SCLK must be inverted. The Microprocessor Interfacing section explains how to interface to some popular DSPs and microcontrollers.
Figures 3, 4, and 5 show the timing diagram for a serial read and write to the AD5532. The serial interface works with both a continuous and a noncontinuous serial clock. The first falling edge of $\overline{\text { SYNC }}$ resets a counter that counts the number of serial clocks to ensure the correct number of bits are shifted in and out of the serial shift registers. Any further edges on SYNC are ignored until the correct number of bits are shifted in or out. Once the correct number of bits for the selected mode have been shifted in or out, the SCLK is ignored. In order for another serial transfer to take place the counter must be reset by the falling edge of SYNC.
In read back, the first rising SCLK edge after the falling edge of $\overline{\text { SYNC }}$ causes $\mathrm{D}_{\text {OUt }}$ to leave its high impedance state and data is clocked out onto the $\mathrm{D}_{\text {out }}$ line and also on subsequent SCLK rising edges. The $\mathrm{D}_{\text {out }}$ pin goes back into a high impedance state on the falling edge of the fourteenth SCLK. Data on the $\mathrm{D}_{\text {IN }}$ line is latched in on the first SCLK falling edge after the falling edge of the SYNC signal and on subsequent SCLK falling edges. During read-back $\mathrm{D}_{\text {IN }}$ is ignored. The serial interface will not shift data in or out until it receives the falling edge of the $\overline{\text { SYNC }}$ signal.

## Parallel Interface (ISHA Mode Only)

The SER $\overline{\text { PAR }}$ Bit must be tied low to enable the parallel interface and disable the serial interface. The parallel interface is controlled by nine pins, which follow:

## $\overline{C S}$

Active low package select pin. This pin is shared with the $\overline{\mathrm{SYNC}}$ function for the serial interface.

## $\overline{W R}$

Active low write pin. The values on the address pins are latched on a rising edge of $\overline{\mathrm{WR}}$.

## A4-A0

Five address pins (A $4=$ MSB of address, $A 0=$ LSB). These are used to address the relevant channel (out of a possible 32).

## OFFSET SEL

Offset select pin. This has the same function as the Offset_Sel bit in the serial interface. When it is high, the offset channel is addressed. The address on A4-A0 is ignored in this case.

## CAL

When this pin is high, all 32 channels acquire $V_{\text {IN }}$ simultaneously. The acquisition time is then $45 \mu \mathrm{~s}$ (typ) and accuracy may be reduced.

## AD5532

## MICROPROCESSOR INTERFACING

## AD5532 to ADSP-21xx Interface

The ADSP-21xx family of DSPs are easily interfaced to the AD5532 without the need for extra logic.
A data transfer is initiated by writing a word to the TX Register after the SPORT has been enabled. In a write sequence, data is clocked out on each rising edge of the DSP's serial clock and clocked into the AD5532 on the falling edge of its SCLK. In read back, 16 bits of data are clocked out of the AD5532 on each rising edge of SCLK and clocked into the DSP on the rising edge of SCLK. $\mathrm{D}_{\text {IN }}$ is ignored. The valid 14 bits of data will be centered in the 16 -bit RX Register when using this configuration. The SPORT Control Register should be set up as follows:

| TFSW | $=$ RFSW $=1$, Alternate Framing |
| :--- | :--- |
| INVRFS | $=$ INVTFS $=1$, Active Low Frame Signal |
| DTYPE | $=00$, Right Justify Data |
| ISCLK | $=1$, Internal Serial Clock |
| TFSR | $=$ RFSR $=1$, Frame Every Word |
| IRFS | $=0$, External Framing Signal |
| ITFS | $=1$, Internal Framing Signal |
| SLEN | $=1001,10-$-Bit Data-Words (ISHA Mode Write) |
| SLEN | $=0111,3 \times 8$-Bit Data-Words (DAC Mode Write) |
| SLEN | $=1111,16$-Bit Data-Words (Read-Back Mode) |

Figure 11 shows the connection diagram.

*ADDITIONAL PINS OMITTED FOR CLARITY
Figure 11. AD5532 to ADSP-2101/ADSP-2103 Interface

## AD5532 to MC68HC11

The serial peripheral interface (SPI) on the MC68HC11 is configured for Master Mode $(M S T R)=1$, Clock Polarity Bit $(\mathrm{CPOL})=0$, and the Clock Phase Bit $(\mathrm{CPHA})=1$. The SPI is configured by writing to the SPI Control Register (SPCR)—see 68 HC 11 User Manual. SCK of the 68 HC 11 drives the SCLK of the AD5532, the MOSI output drives the serial data line ( $\mathrm{D}_{\text {IN }}$ ) of the AD5532, and the MISO input is driven from $\mathrm{D}_{\text {Out. }}$. The $\overline{\text { SYNC signal is derived from a port line (PC7). When data is }}$ being transmitted to the AD5532, the $\overline{\text { SYNC }}$ line is taken low (PC7). Data appearing on the MOSI output is valid on the falling edge of SCK. Serial data from the 68 HC 11 is transmitted in 8 -bit bytes with only eight falling clock edges occurring in the transmit cycle. Data is transmitted MSB first. To transmit 10 data bits in ISHA Mode, it is important to left-justify the data in the SPDR Register. PC7 must be pulled low to start a transfer. It is taken high and pulled low again before any further read/write cycles can take place. A connection diagram is shown in Figure 12.

*ADDITIONAL PINS OMITTED FOR CLARITY
Figure 12. AD5532 to MC68HC11 Interface

## AD5532 to PIC16C6x/7x

The PIC16C6x/7x synchronous serial port (SSP) is configured as an SPI master with the Clock Polarity Bit $=0$. This is done by writing to the Synchronous Serial Port Control Register (SSPCON). See the PIC16/17 Microcontroller User Manual. In this example, the I/O port RA1 is being used to pulse $\overline{\text { SYNC }}$ and enable the serial port of the AD5532. This microcontroller transfers only eight bits of data during each serial transfer operation; therefore, two or three consecutive read/write operations are needed depending on the mode. Figure 13 shows the connection diagram.

*ADDITIONAL PINS OMITTED FOR CLARITY
Figure 13. AD5532 to PIC16C6x/7x Interface

## AD5532 to 8051

The AD5532 requires a clock synchronized to the serial data. The 8051 serial interface must therefore be operated in Mode 0 . In this mode, serial data enters and exits through RxD and a shift clock is output on TxD. Figure 14 shows how the 8051 is connected to the AD5532. Because the AD5532 shifts data out on the rising edge of the shift clock and latches data in on the falling edge, the shift clock must be inverted. The AD5532 requires its data with the MSB first. Since the 8051 outputs the LSB first, the transmit routine must take this into account.

*ADDITIONAL PINS OMITTED FOR CLARITY
Figure 14. AD5532 to 8051 Interface

## APPLICATION CIRCUITS

## AD5532 in a Typical ATE System

The AD5532 is ideally suited for use in automatic test equipment. Several DACs are required to control pin drivers, comparators, active loads, and signal timing. Traditionally, sample-and-hold devices were used in this application.
The AD5532 has several advantages: no refreshing is required, there is no droop, pedestal error is eliminated, and there is no need for extra filtering to remove glitches. Overall a higher level of integration is achieved in a smaller area (see Figure 15).


Figure 15. AD5532 in an ATE System

## Typical Application Circuit (DAC Mode)

The AD5532 can be used in many optical networking applications that require a large number of DACs to perform control and measurement functions. In the example shown in Figure 16, the outputs of the AD5532 are amplified and used to control actuators that determine the position of MEMS mirrors in an optical switch. The exact position of each mirror is measured using sensors. The sensor readings are muxed using four dual 4-channel matrix switches (ADG739) and fed back to an 8 -channel 14-bit ADC (AD7856).
The control loop is driven by an ADSP-2191M, a 16-bit fixedpoint DSP with 3 SPORT interfaces and 2 SPI ports. The DSP uses some of these serial ports to write data to the DAC, control the multiplexer, and read back data from the ADC.


Figure 16. Typical Optical Control and Measurement Application Circuit

## Typical Application Circuit (ISHA Mode)

The AD5532 can be used to set up voltage levels on 32 channels as shown in the circuit that follows. An AD780 provides the 3 V reference for the AD5532 and for the AD5541 16-bit DAC. A simple 3-wire interface is used to write to the AD5541. Because the AD5541 has an output resistance of $6.25 \mathrm{k} \Omega$ (typ), the time taken to charge/discharge the capacitance at the $\mathrm{V}_{\text {IN }}$ pin is significant. Hence an AD820 is used to buffer the DAC output. Note that it is important to minimize noise on $\mathrm{V}_{\text {IN }}$ and REFIN when laying out the circuit.


Figure 17. Typical Application Circuit (ISHA Mode)

## POWER SUPPLY DECOUPLING

In any circuit where accuracy is important, careful consideration of the power supply and ground return layout helps to ensure the rated performance. The printed circuit board on which the AD5532 is mounted should be designed so that the analog and digital sections are separated and confined to certain areas of the board. If the AD 5532 is in a system where multiple devices require an AGND-to-DGND connection, the connection should be made at one point only. The star ground point should be established as close as possible to the device. For supplies with multiple pins ( $V_{S S}, V_{D D}, A V_{C C}$ ) it is recommended to tie those pins together. The AD5532 should have ample supply bypassing of $10 \mu \mathrm{~F}$ in parallel with $0.1 \mu \mathrm{~F}$ on each supply located as close to the package as possible, ideally right up against the device. The $10 \mu \mathrm{~F}$ capacitors are the tantalum bead type. The $0.1 \mu \mathrm{~F}$ capacitor should have low effective series resistance (ESR) and effective series inductance (ESI), such as the common ceramic types that provide a low impedance path to ground at high frequencies, to handle transient currents due to internal logic switching.
The power supply lines of the AD5532 should use as large a trace as possible to provide low impedance paths and reduce the effects of glitches on the power supply line. Fast switching signals, such as clocks, should be shielded with digital ground to avoid radiating noise to other parts of the board and should never be run near the reference inputs. A ground line routed between the $\mathrm{D}_{\mathrm{IN}}$ and SCLK lines will help reduce crosstalk between them (not required on a multilayer board as there will be a separate ground plane, but separating the lines will help).
Note it is essential to minimize noise on $\mathrm{V}_{\text {IN }}$ and REFIN lines. Particularly for optimum ISHA performance, the $\mathrm{V}_{\text {IN }}$ line must be kept noise-free. Depending on the noise performance of the board, a noise filtering capacitor may be required on the $\mathrm{V}_{\text {IN }}$ line. If this capacitor is necessary, then for optimum throughput it may be necessary to buffer the source which is driving $\mathrm{V}_{\text {IN }}$. Avoid crossover of digital and analog signals. Traces on opposite sides of the board should run at right angles to each other. This reduces the effects of feedthrough through the board. A microstrip technique is by far the best, but not always possible with a double-sided board. In this technique, the component side of the board is dedicated to ground plane while signal traces are placed on the solder side.
As is the case for all thin packages, care must be taken to avoid flexing the package and to avoid a point load on the surface of the package during the assembly process.

## OUTLINE DIMENSIONS

## 74-Ball Low-Profile Square Ball Grid Array [LFBGA] <br> (BC-74) <br> Dimensions shown in millimeters


Location ..... Page6/02-Data Sheet changed from REV. A to REV. B.Term SHA changed to ISHAGlobal
Edits to ABSOLUTE MAXIMUM RATINGS ..... 6
Edits to ORDERING GUIDE ..... 6
Edits to FUNCTIONAL DESCRIPTION ..... 11
Edits to Table I ..... 11
Edits to ISHA Mode ..... 11
Figure 16 and accompanying text added ..... 15
Edits to POWER SUPPLY DECOUPLING section ..... 15


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[^1]:    *N/C = Not Connected

